

|    |       | Search Text   | Des   | Time Stamp       |
|----|-------|---|---|------------------|
| 1  | 215   | esd with buried   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2004/08/17 11:18 |
| 2  | 319   | esd same (under or below) with pad  | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2004/08/17 11:19 |
| 3  | 41456 | vias with resistance  | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2004/08/17 11:59 |
| 4  | 1857  | vias with resistance with parallel  | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2004/08/17 11:38 |
| 5  | 9148  | 257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.  | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2004/08/17 11:39 |
| 6  | 258   | esd and (resistance or resistor) and (transistor same below same pad)   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2004/08/17 11:39 |
| 7  | 4148  | 257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried)   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2004/08/17 11:39 |
| 8  | 44    | (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried)  | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 9  | 28    | (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried) and pad  | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 10 | 16    | ((257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried)) not ((257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried) and pad)   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 11 | 25    | (esd same (under or below) with pad) and (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.)   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 12 | 93    | ((esd same (under or below) with pad) and (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) not ((257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried))) not ((257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried) and pad) | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 13 | 52    | esd and (resistor or resistor) and (esd below same pad) and (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.)  | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 14 | 5     | (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried) and spds"20040817"   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 15 | 4     | (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried) and pad and spds"20040817"   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 16 | 1     | ((257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried)) not ((257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried) and pad)   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 17 | 6     | esd same (under or below) with pad) and (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (spds"20040817"  | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 18 | 6     | ((esd same (under or below) with pad) and (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried)) not ((257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried) and pad) and spds"20040817"   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 19 | 6     | esd and (resistor or resistor) and (transistor same below same pad) and (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (257/173, 355.cc1s. 361/90, 91, 91.1-91.8, FOR100.cc1s.) and (esd with buried) and pad)  | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/01/12       |
| 20 | 14    | S14 S15 S16 S17 S18 S19<br>spds"20040817"   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 2005/06/30       |
| 21 | 2     | #6762466-.pn  | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 11:26            |
| 22 | 0     | *10/758173"   | US-GPUS; USPAI; EPO; JPO; DERVENT; IBM-TDA; IBM-TDR; IBM-TIA; | 13:59            |

updated east 6/30/05